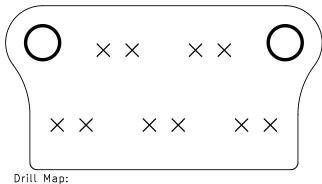
NOTES:

1. LAYERS: 2
2. PCB THICKNESS: 1.6mm
3. PCB COLOR: BLUE
4. SILKSCREEN: WHITE
5. MATERIAL TYPE: FR4 TG-155
6. SURFACE FINISH: HASL (Lead Free)
7. OUTER COPPER WEIGHT: 1oz
8. IMPEDANCE CONTROL: NO
9. BOARD OUTLINE TOLERANCE: +/-0.2mm



X 1.092mm / 0.0430" (10 holes) O 3.000mm / 0.1181" (2 holes) (not plated)

Layer Name	Туре	Material	Thickness (mils)	Color	Epsilon R	Loss Tangent
F.Silkscreen	Top Silk Screen	Not specified	0 mils	Not specified	1	0
F.Paste	Top Solder Paste		0 mils		1	0
F.Mask	Top Solder Mask	Not specified	0.3937 mils	Blue	3.3	0
F.Cu	copper		1.37795 mils		1	0
Dielectric 1	core	FR4	59.44882 mils	Not specified	4.5	0.02
B.Cu	copper		1.37795 mils		1	0
B.Mask	Bottom Solder Mask	Not specified	0.3937 mils	Blue	3.3	0
B.Paste	Bottom Solder Paste		0 mils		1	0
B.Silkscreen	Bottom Silk Screen	Not specified	0 mils	Not specified	1	0

## **BOARD CHARACTERISTICS**

Copper Layer Count: Board Thickness: 62.99 mils

Board overall dimensions: 1099.19 mils x 569.39 mils

0.00 mils / 0.00 mils Min hole diameter: 11.81 mils Min track/spacing: Copper Finish: Impedance Control: No None Castellated pads: No

Edge card connectors: No Plated Board Edge: No

Sheet: File: TEE—CAN.kicad\_pcb

Title: TEE CAN (WCP-1824)

Size: B Date: 2024-12-14 KiCad E.D.A. 8.0.7 Rev: 1 ld: 1/1